# **BGU7005**

# SiGe:C Low Noise Amplifier MMIC for GPS, GLONASS, Galileo and Compass

Rev. 5 — 29 March 2012

**Product data sheet** 

## 1. Product profile

#### 1.1 General description

The BGU7005 is a Low Noise Amplifier (LNA) for GNSS receiver applications in a plastic leadless 6-pin, extremely small SOT886 package. The BGU7005 requires only one external matching inductor and one external decoupling capacitor.

The BGU7005 adapts itself to the changing environment resulting from co-habitation of different radio systems in modern cellular handsets. It has been designed for low power consumption and optimal performance when jamming signals from co-existing cellular transmitters are present. At low jamming power levels it delivers 16.5 dB gain at a noise figure of 0.85 dB. During high jamming power levels, resulting for example from a cellular transmit burst, it temporarily increases its bias current to improve sensitivity.

#### **CAUTION**



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

#### 1.2 Features and benefits

- Covers full GNSS L1 band, from 1559 MHz to 1610 MHz
- Noise figure (NF) = 0.85 dB
- Gain 16.5 dB
- High input 1 dB compression point P<sub>i(1dB)</sub> of -11 dBm
- High out of band IP3<sub>i</sub> of 9 dBm
- Supply voltage 1.5 V to 3.1 V
- Power-down mode current consumption < 1 μA</p>
- Optimized performance at low supply current of 4.5 mA
- Integrated matching for the output
- Requires only one input matching inductor and one supply decoupling capacitor
- Input and output DC decoupled
- ESD protection on all pins (HBM > 2 kV)
- Integrated temperature stabilized bias for easy design
- Small 6-pin leadless package 1 mm × 1.45 mm × 0.5 mm
- 110 GHz transit frequency SiGe:C technology



#### SiGe:C LNA MMIC for GPS, GLONASS, Galileo and Compass

### 1.3 Applications

■ LNA for GPS, GLONASS, Galileo and Compass (BeiDou) in smart phones, feature phones, tablet PCs, Personal Navigation Devices, Digital Still Cameras, Digital Video Cameras, RF Front End modules, complete GPS chipset modules and theft protection (laptop, ATM).

#### 1.4 Quick reference data

Table 1. Quick reference data

f = 1559 MHz to 1610 MHz;  $V_{CC}$  = 1.8 V;  $P_i$  < -40 dBm;  $T_{amb}$  = 25 °C; input matched to 50  $\Omega$  using a 5.6 nH inductor; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{CC}$	supply voltage	RF input AC coupled		1.5	-	3.1	V
I <sub>CC</sub>	supply current	$V_{ENABLE} \ge 0.8 \ V$					
		$P_i < -40 \text{ dBm}$		3.2	4.5	5.7	mΑ
		$P_i = -20 \text{ dBm}$		8.1	11.6	5.7 6 14.4 5 19 5 20 5 1.2 1.3 1.6	mΑ
Gp	power gain	$P_i < -40$ dBm, no jammer		14	16.5	19	dB
		$P_i = -20 \text{ dBm}$ , no jammer		15	17.5	20	dB
NF	noise figure	$P_i < -40$ dBm, no jammer	[1]	-	0.85	1.2	dB
		P <sub>i</sub> < -40 dBm, no jammer	[2]	-	0.9	1.3	dB
		$P_i = -20 \text{ dBm}$ , no jammer		-	1.2	3.1 5.7 14.4 19 20 1.2 1.3 1.6	dB
P <sub>i(1dB)</sub>	input power at 1 dB	f = 1575 MHz					
	gain compression	V <sub>CC</sub> = 1.5 V		-15	-12	3.1 5.7 14.4 19 20 1.2 1.3 1.6	dBm
		V <sub>CC</sub> = 1.8 V		-14	-11	-	dBm
		V <sub>CC</sub> = 2.85 V		-11	-8	3.1 5.7 14.4 19 20 1.2 1.3 1.6	dBm
IP3 <sub>i</sub>	input third-order intercept point	f = 1.575 GHz					
		V <sub>CC</sub> = 1.5 V	[3]	5	8	-	dBm
		V <sub>CC</sub> = 1.8 V	[3]	5	9	-	dBm
		V <sub>CC</sub> = 2.85 V	[3]	5	12	-	dBm

<sup>[1]</sup> PCB losses are subtracted.

## 2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	GND		
2	GND		4 5
3	RF_IN		3—6
4	$V_{CC}$		
5	ENABLE		2 1 sym129
6	RF_OUT		3,=3

BGU7005

<sup>[2]</sup> Including PCB losses.

<sup>[3]</sup>  $f_1 = 1713 \text{ MHz}$ ;  $f_2 = 1851 \text{ MHz}$ ;  $P_1 = P_2 = -30 \text{ dBm}$ .

#### SiGe:C LNA MMIC for GPS, GLONASS, Galileo and Compass

## 3. Ordering information

Table 3. Ordering information

Type number							
	Name	Description	Version				
BGU7005	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1.45 $\times$ 0.5 mm	SOT886				

## 4. Marking

Table 4. Marking codes

Type number	Marking code
BGU7005	AC

## 5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage	RF input AC coupled	-0.5	+5.0	V
$V_{ENABLE}$	voltage on pin ENABLE	$V_{\text{ENABLE}} < V_{\text{CC}} + 0.6$	<sup>[2]</sup> -0.5	+5.0	V
$V_{RF\_IN}$	voltage on pin RF_IN	DC; $V_{RF_IN} < V_{CC} + 0.6$	[2][3] -0.5	+5.0	V
$V_{RF\_OUT}$	voltage on pin RF_OUT	DC; $V_{RF\_OUT} < V_{CC} + 0.6$	[2][3] -0.5	+5.0	V
$P_{i}$	input power		-	0	dBm
P <sub>tot</sub>	total power dissipation	$T_{sp} \le 130  ^{\circ}C$	<u>[1]</u>	55	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
V <sub>ESD</sub>	electrostatic discharge voltage	Human Body Model (HBM); According JEDEC standard 22-A114E	-	4	kV
		Charged Device Model (CDM); According JEDEC standard 22-C101B	-	1	kV

<sup>[1]</sup>  $T_{sp}$  is the temperature at the soldering point of the emitter lead.

#### 6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		225	K/W

BGU7005

<sup>[2]</sup> Warning: due to internal ESD diode proctection, the applied DC voltage should not exceed V<sub>CC</sub> + 0.6 and shall not exceed 5.0 V in order to avoid excess current.

<sup>[3]</sup> The RF input and RF output are AC coupled through internal DC blocking capacitor.

#### SiGe:C LNA MMIC for GPS, GLONASS, Galileo and Compass

## 7. Characteristics

#### Table 7. Characteristics

f = 1559 MHz to 1610 MHz;  $V_{CC}$  = 1.8 V;  $V_{ENABLE} \ge 0.8$  V;  $P_i$  < -40 dBm;  $T_{amb}$  = 25 °C; input matched to 50  $\Omega$  using a 5.6 nH inductor; unless otherwise specified.

Symbol	Parameter	Conditions	Mir	тур	Max	Unit
$V_{CC}$	supply voltage	RF input AC coupled	1.5	-	3.1	V
I <sub>CC</sub>	supply current	$V_{\text{ENABLE}} \ge 0.8 \text{ V}$				
		P <sub>i</sub> < -40 dBm	3.2	4.5	5.7	mΑ
		$P_i = -20 \text{ dBm}$	8.1	11.6	14.4	mΑ
		$V_{\text{ENABLE}} \leq 0.35 \text{ V}$	-	-	1	μΑ
T <sub>amb</sub>	ambient temperature		-40	+25	+85	°C
Gp	power gain	T <sub>amb</sub> = 25 °C				
		P <sub>i</sub> < −40 dBm, no jammer	14	16.5	19	dB
		$P_i = -20$ dBm, no jammer	15	17.5	20	dB
		$P_{jam} = -20 \text{ dBm}; f_{jam} = 850 \text{ MHz}$	15	17.5	20	dB
		$P_{jam} = -20 \text{ dBm}; f_{jam} = 1850 \text{ MHz}$	15	17.5	20	dB
		-40 °C ≤ T <sub>amb</sub> ≤ +85 °C				
		P <sub>i</sub> < -40 dBm, no jammer	13	-	20	dB
		P <sub>i</sub> = −20 dBm, no jammer	14	-	21	dB
		$P_{jam} = -20 \text{ dBm}; f_{jam} = 850 \text{ MHz}$	14	-	21	dB
		$P_{jam} = -20 \text{ dBm}; f_{jam} = 1850 \text{ MHz}$	14	-	21	dB
RLin	input return loss	P <sub>i</sub> < -40 dBm	5	8	-	dB
		$P_i = -20 \text{ dBm}$	6	10	-	dB
RL <sub>out</sub>	output return loss	$P_i < -40 \text{ dBm}$	10	20	-	dB
		$P_i = -20 \text{ dBm}$	10	14	-	dB
ISL	isolation		20	23	-	dB
NF	noise figure	T <sub>amb</sub> = 25 °C				
		P <sub>i</sub> < -40 dBm, no jammer	<u>[1]</u> _	0.85	1.2	dB
		P <sub>i</sub> < -40 dBm, no jammer	[2] _	0.9	1.3	dB
		P <sub>i</sub> = −20 dBm, no jammer	-	1.2	1.6	dB
		$P_{jam} = -20 \text{ dBm}; f_{jam} = 850 \text{ MHz}$	-	1.1	1.5	dB
		$P_{jam} = -20 \text{ dBm}; f_{jam} = 1850 \text{ MHz}$	-	1.3	1.7	dB
		$-40  ^{\circ}\text{C} \le \text{T}_{\text{amb}} \le +85  ^{\circ}\text{C}$				
		P <sub>i</sub> < -40 dBm, no jammer	-	-	1.7	dB
		$P_i = -20$ dBm, no jammer	-	-	1.9	dB
		$P_{jam} = -20 \text{ dBm}; f_{jam} = 850 \text{ MHz}$	-	-	1.8	dB
		$P_{jam} = -20 \text{ dBm}; f_{jam} = 1850 \text{ MHz}$	-	-	2.0	dB

**BGU7005 NXP Semiconductors** 

#### SiGe: C LNA MMIC for GPS, GLONASS, Galileo and Compass

Characteristics ... continued Table 7.

f = 1559 MHz to 1610 MHz;  $V_{CC}$  = 1.8 V;  $V_{ENABLE}$   $\geq$  0.8 V;  $P_i$  < -40 dBm;  $T_{amb}$  = 25 °C; input matched to 50 Ω using a 5.6 nH inductor; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
P <sub>i(1dB)</sub>	input power at 1 dB gain compression	f = 1575 MHz					
		V <sub>CC</sub> = 1.5 V		-15	-12	-	dBm
		V <sub>CC</sub> = 1.8 V		-14	-11	-	dBm
		V <sub>CC</sub> = 2.85 V		-11	-8	-	dBm
		f = 806 MHz to 928 MHz					
		V <sub>CC</sub> = 1.5 V	[3]	-15	-12	-	dBm
		V <sub>CC</sub> = 1.8 V	[3]	-14	-11	-	dBm
		V <sub>CC</sub> = 2.85 V	[3]	-14	-11	-	dBm
		f = 1612 MHz to 1909 MHz					
		V <sub>CC</sub> = 1.5 V	[3]	-13	-10	-	dBm
		V <sub>CC</sub> = 1.8 V	[3]	-12	-9	-	dBm
		V <sub>CC</sub> = 2.85 V	[3]	-10	-7		dBm
IP3 <sub>i</sub>	input third-order intercept point	f = 1.575 GHz					
		V <sub>CC</sub> = 1.5 V	<u>[4]</u>	5	8	-	dBm
		V <sub>CC</sub> = 1.8 V	<u>[4]</u>	5	9	-	dBm
		V <sub>CC</sub> = 2.85 V	[4]	5	12	-	dBm
t <sub>on</sub>	turn-on time		<u>[5]</u>	-	-	2	μS
t <sub>off</sub>	turn-off time		[5]	-	-	1	μS
K	Rollett stability factor			1	-	-	

<sup>[1]</sup> PCB losses are subtracted.

**Table 8. ENABLE (pin 5)** -40 °C ≤  $T_{amb}$  ≤ +85 °C; 1.5 V ≤  $V_{CC}$  ≤ 3.1 V

V <sub>ENABLE</sub> (V)	State
≤ 0.35	OFF
≥ 0.8	ON

<sup>[2]</sup> Including PCB losses.

<sup>[3]</sup> Out of band.

<sup>[4]</sup>  $f_1 = 1713 \text{ MHz}$ ;  $f_2 = 1851 \text{ MHz}$ ;  $P_1 = P_2 = -30 \text{ dBm}$ .

<sup>[5]</sup> Within 10 % of the final gain.

## SiGe:C LNA MMIC for GPS, GLONASS, Galileo and Compass

## 8. Application information

#### 8.1 GNSS LNA

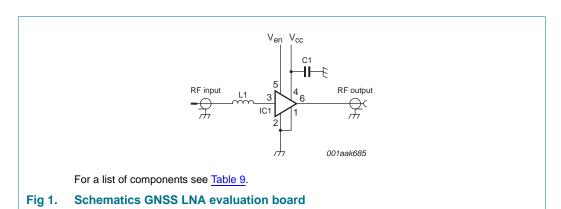
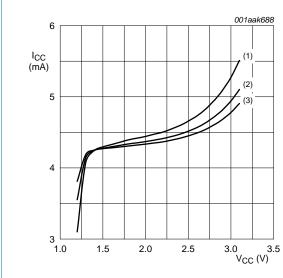


Table 9. List of components

For schematics see Figure 1.

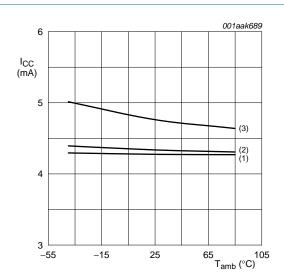
Component	Description	Value	Supplier	Remarks
C1	decoupling capacitor	1 nF	various	
IC1	BGU7005	-	NXP	
L1	high quality matching inductor	5.6 nH	Murata LQW15A	





- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = +25 \, ^{\circ}C$
- (3)  $T_{amb} = +85 \, ^{\circ}C$

Fig 2. Supply current as a function of supply voltage; typical values

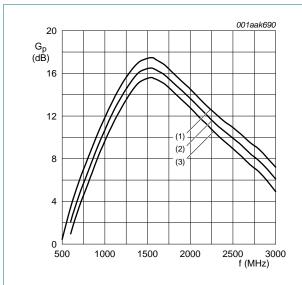


 $P_i = -45 \text{ dBm}.$ 

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

Fig 3. Supply current as a function of ambient temperature; typical values

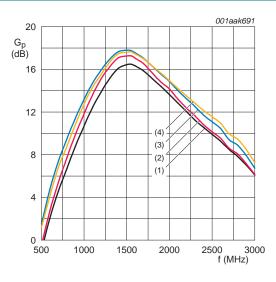
#### SiGe: C LNA MMIC for GPS, GLONASS, Galileo and Compass



 $V_{CC} = 1.8 \text{ V}; P_i = -45 \text{ dBm}.$ 

- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = +25 \, ^{\circ}C$
- (3)  $T_{amb} = +85 \, ^{\circ}C$

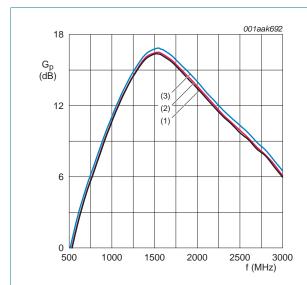
Fig 4. Power gain as a function of frequency; typical values



 $V_{CC}$  = 1.8 V;  $T_{amb}$  = 25 °C.

- (1)  $P_i = -45 \text{ dBm}$
- (2)  $P_i = -30 \text{ dBm}$
- (3)  $P_i = -20 \text{ dBm}$
- (4)  $P_i = -15 \text{ dBm}$

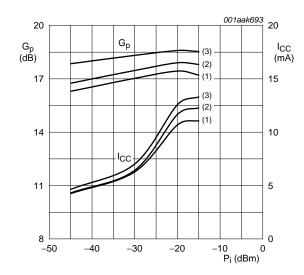
Fig 5. Power gain as a function of frequency; typical values



 $P_i = -45 \text{ dBm}$ ;  $T_{amb} = 25 \text{ °C}$ .

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

Fig 6. Power gain as a function of frequency; typical values

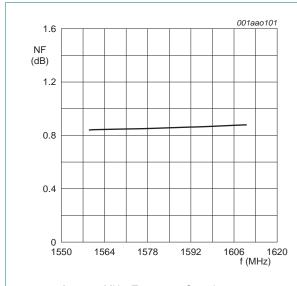


 $T_{amb} = 25 \, ^{\circ}C$ ; f = 1575 MHz.

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

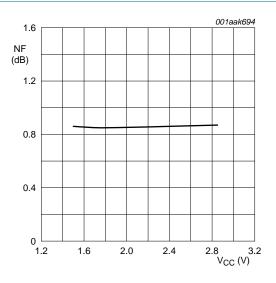
Fig 7. Power gain as a function of input power; typical values

#### SiGe: C LNA MMIC for GPS, GLONASS, Galileo and Compass



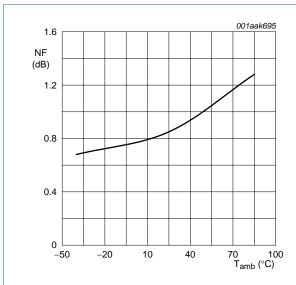
f = 1575 MHz;  $T_{amb}$  = 25 °C; no jammer.

Fig 8. Noise figure as a function of frequency; typical values

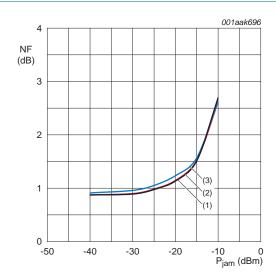


f = 1575 MHz;  $T_{amb} = 25 \, ^{\circ}\text{C}$ ; no jammer.

Fig 9. Noise figure as a function of supply voltage; typical values



f = 1575 MHz;  $V_{CC} = 1.8 \text{ V}$ ; no jammer.



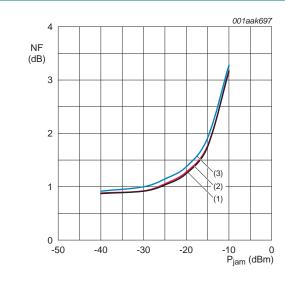
 $f_{jam}$ = 850 MHz;  $T_{amb}$  = 25 °C; f = 1575 MHz.

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

Fig 11. Noise figure as a function of jamming power; typical values

Fig 10. Noise figure as a function of ambient temperature; typical values

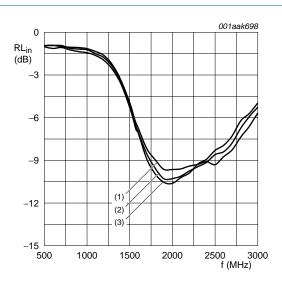
#### SiGe:C LNA MMIC for GPS, GLONASS, Galileo and Compass



 $f_{jam}$ = 1850 MHz;  $T_{amb}$  = 25 °C; f = 1575 MHz.

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

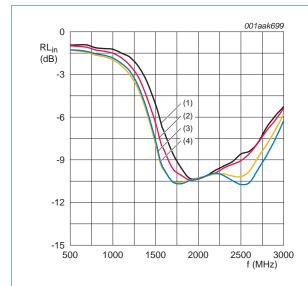
Fig 12. Noise figure as a function of jamming power; typical values



 $V_{CC} = 1.8 \text{ V}; P_i = -45 \text{ dBm}.$ 

- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = +25 \, ^{\circ}C$
- (3)  $T_{amb} = +85 \, ^{\circ}C$

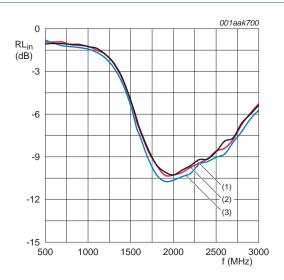
Fig 13. Input return loss as a function of frequency; typical values



 $V_{CC} = 1.8 \text{ V}; T_{amb} = 25 ^{\circ}\text{C}.$ 

- (1)  $P_i = -45 \text{ dBm}$
- (2)  $P_i = -30 \text{ dBm}$
- (3)  $P_i = -20 \text{ dBm}$
- (4)  $P_i = -15 \text{ dBm}$

Fig 14. Input return loss as a function of frequency; typical values

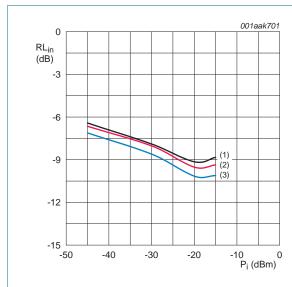


 $P_i = -45 \text{ dBm}$ ;  $T_{amb} = 25 \text{ °C}$ .

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

Fig 15. Input return loss as a function of frequency; typical values

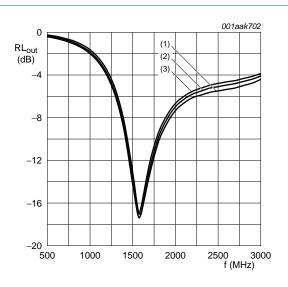
#### SiGe:C LNA MMIC for GPS, GLONASS, Galileo and Compass



 $T_{amb} = 25$  °C; f = 1575 MHz.

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

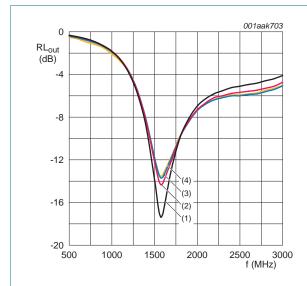
Fig 16. Input return loss as a function of input power; typical values



 $V_{CC} = 1.8 \text{ V}; P_i = -45 \text{ dBm}.$ 

- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = +25 \, ^{\circ}C$
- (3)  $T_{amb} = +85 \, ^{\circ}C$

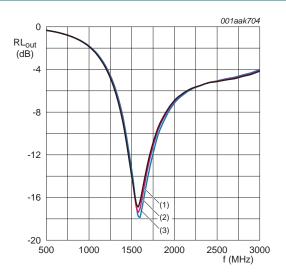
Fig 17. Output return loss as a function of frequency; typical values



 $V_{CC} = 1.8 \text{ V}; T_{amb} = 25 ^{\circ}\text{C}.$ 

- (1)  $P_i = -45 \text{ dBm}$
- (2)  $P_i = -30 \text{ dBm}$
- (3)  $P_i = -20 \text{ dBm}$
- (4)  $P_i = -15 \text{ dBm}$

Fig 18. Output return loss as a function of frequency; typical values

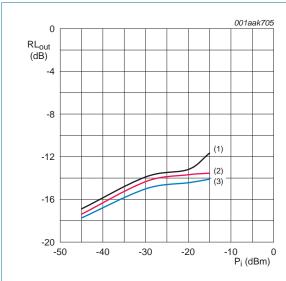


 $P_i = -45 \text{ dBm}$ ;  $T_{amb} = 25 ^{\circ}\text{C}$ .

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

Fig 19. Output return loss as a function of frequency; typical values

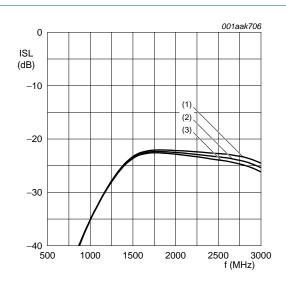
#### SiGe: C LNA MMIC for GPS, GLONASS, Galileo and Compass



 $T_{amb} = 25 \, ^{\circ}C; f = 1575 \, MHz.$ 

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

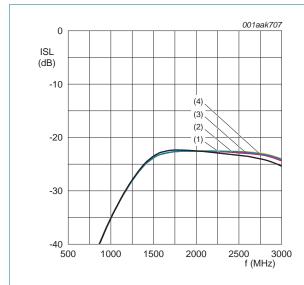
Fig 20. Output return loss as a function of input power; typical values



$$V_{CC} = 1.8 \text{ V}; P_i = -45 \text{ dBm}.$$

- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = +25 \, ^{\circ}C$
- (3)  $T_{amb} = +85 \, ^{\circ}C$

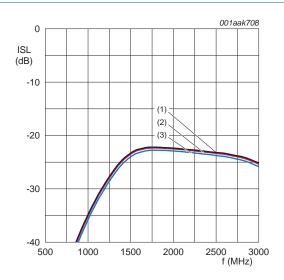
Fig 21. Isolation as a function of frequency; typical values



 $V_{CC} = 1.8 \text{ V}; T_{amb} = 25 ^{\circ}\text{C}.$ 

- (1)  $P_i = -45 \text{ dBm}$
- (2)  $P_i = -30 \text{ dBm}$
- (3)  $P_i = -20 \text{ dBm}$
- (4)  $P_i = -15 \text{ dBm}$

Fig 22. Isolation as a function of frequency; typical values

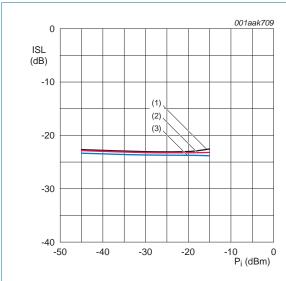


 $P_i = -45 \text{ dBm}$ ;  $T_{amb} = 25 \text{ }^{\circ}\text{C}$ .

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

Fig 23. Isolation as a function of frequency; typical values

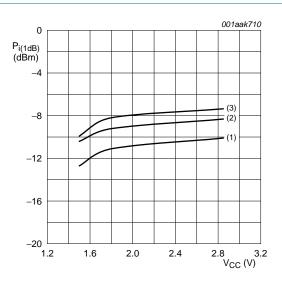
#### SiGe: C LNA MMIC for GPS, GLONASS, Galileo and Compass



 $T_{amb} = 25 \, ^{\circ}C; f = 1575 \, MHz.$ 

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

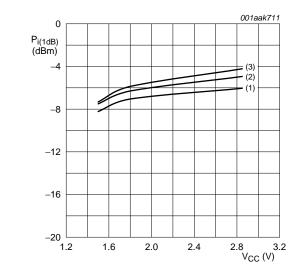
Fig 24. Isolation as a function of input power; typical values



f = 850 MHz.

- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = +25 \, ^{\circ}C$
- (3)  $T_{amb} = +85 \, ^{\circ}C$

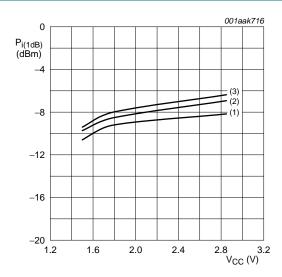
Fig 25. Input power at 1 dB gain compression as a function of supply voltage; typical values



f = 1850 MHz.

- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = +25 \, ^{\circ}C$
- (3)  $T_{amb} = +85 \, ^{\circ}C$

Fig 26. Input power at 1 dB gain compression as a function of supply voltage; typical values

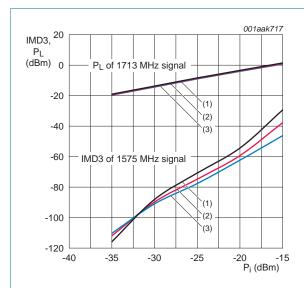


f = 1575 MHz.

- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = +25 \, ^{\circ}C$
- (3)  $T_{amb} = +85 \, ^{\circ}C$

Fig 27. Input power at 1 dB gain compression as a function of supply voltage; typical values

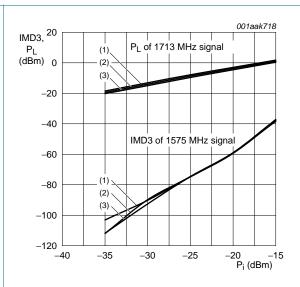
#### SiGe:C LNA MMIC for GPS, GLONASS, Galileo and Compass



 $f = 1575 \text{ MHz}; f_1 = 1713 \text{ MHz}; f_2 = 1851 \text{ MHz}; T_{amb} = 25 \,^{\circ}\text{C}.$ 

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

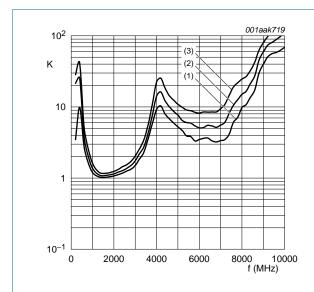
Fig 28. Third order intermodulation distortion and output power as function of input power; typical values



f = 1575 MHz;  $f_1$  = 1713 MHz;  $f_2$  = 1851 MHz;  $V_{CC}$  = 1.8 V.

- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = +25 \, ^{\circ}C$
- (3)  $T_{amb} = +85 \, ^{\circ}C$

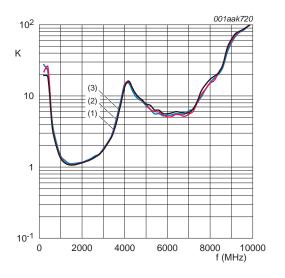
Fig 29. Third order intermodulation distortion and output power as function of input power; typical values



 $T_{amb} = 25 \, ^{\circ}C; \, P_i = -45 \, dBm.$ 

- (1)  $V_{CC} = 1.5 \text{ V}$
- (2)  $V_{CC} = 1.8 \text{ V}$
- (3)  $V_{CC} = 2.85 \text{ V}$

Fig 30. Rollett stability factor as a function of frequency; typical values



 $V_{CC} = 1.8 \text{ V}; P_i = -45 \text{ dBm}.$ 

- (1)  $T_{amb} = -40 \, ^{\circ}C$
- (2)  $T_{amb} = +25 \, ^{\circ}C$
- (3)  $T_{amb} = +85 \, ^{\circ}C$

Fig 31. Rollett stability factor as a function of frequency; typical values

**BGU7005 NXP Semiconductors** 

#### SiGe: C LNA MMIC for GPS, GLONASS, Galileo and Compass

#### 8.2 GPS front-end

The GPS LNA is typically used in a GPS front-end. A GPS front-end application circuit and its characteristics is provided here.

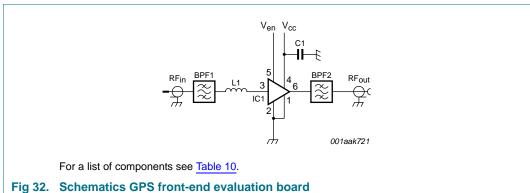


Table 10. List of components

For schematics see Figure 32.

Component	Description	Value	Supplier	Remarks
Component	Description	value	Supplier	Remarks
BPF1, BPF2	GPS SAW filter	-	Murata SAFEA1G57KE0F00	Alternatives from Epcos:
				• B9444
				Alternatives from Murata:
				<ul><li>SAFEA1G57KH0F00</li></ul>
				<ul><li>SAFEA1G57KB0F00</li></ul>
				Alternatives from Fujitsu:
				<ul> <li>FAR-F6KA-1G5754-L4AA</li> </ul>
				<ul> <li>FAR-F6KA-1G5754-L4AJ</li> </ul>
C1	decoupling capacitor	1 nF	Various	
IC1	BGU7005	-	NXP	
L1	high quality matching inductor	5.6 nH	Murata LQW15A	

#### 8.3 Characteristics GPS front-end

#### Table 11. Characteristics GPS front-end

f = 1575 MHz;  $V_{CC}$  = 1.8 V;  $V_{ENABLE} \ge 0.8$  V; power at LNA input  $P_i$  < -40 dBm;  $T_{amb}$  = 25 °C; input and output matched to 50  $\Omega$ ; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage	RF input AC coupled	1.5	-	2.85	V
I <sub>CC</sub>	supply current		-	4.5	-	mΑ
$T_{amb}$	ambient temperature		-40	+25	+85	°C
$G_p$	power gain	power at LNA input P <sub>i</sub> < -40 dBm	1] -	14.5	-	dB
		power at LNA input $P_i = -20 \text{ dBm}$	1] -	15.5	-	dB
$RL_in$	input return loss	power at LNA input P <sub>i</sub> < -40 dBm	1] -	8.5	-	dB
		power at LNA input $P_i = -20 \text{ dBm}$	1] -	10.5	-	dB
$RL_{out}$	output return loss	power at LNA input P <sub>i</sub> < -40 dBm	1] -	14.5	-	dB
		power at LNA input P <sub>i</sub> = −20 dBm	<u>1]</u> _	12.5	-	dB

All information provided in this document is subject to legal disclaimers. © NXP B.V. 2012. All rights reserved.

#### SiGe: C LNA MMIC for GPS, GLONASS, Galileo and Compass

Table 11. Characteristics GPS front-end ...continued

f = 1575 MHz;  $V_{CC}$  = 1.8 V;  $V_{ENABLE} \ge 0.8$  V; power at LNA input  $P_i$  < -40 dBm;  $T_{amb}$  = 25 °C; input and output matched to 50  $\Omega$ ; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
NF	noise figure	power at LNA input P <sub>i</sub> < -40 dBm	[1]	-	1.8	-	dB
		power at LNA input $P_i = -20 \text{ dBm}$	[1]	-	1.9	-	dB
P <sub>i(1dB)</sub>	input power at 1 dB gain compression	f = 1575 MHz			-8.2		dBm
		f = 806 MHz to 928 MHz	[2]		31		dBm
		f = 1612 MHz to 1909 MHz	[2]		40		dBm
IP3 <sub>i</sub>	input third-order intercept point		[3]		64		dBm
α	attenuation	f = 850 MHz	[4]	95	-	-	dBc
		f = 1850 MHz	[4]	90	-	-	dBc
t <sub>on</sub>	turn-on time		[5]	-	-	2	μS
t <sub>off</sub>	turn-off time		[5]	-	-	1	μS

<sup>[1]</sup> Power at GPS front-end input = power at LNA input + attenuation BPF1.

<sup>[2]</sup> Out of band.

<sup>[3]</sup>  $f_1 = 1713 \text{ MHz}$ ;  $f_2 = 1851 \text{ MHz}$ ;  $P_1 = P_2 = +10 \text{ dBm}$ .

<sup>[4]</sup> Relative to f = 1575 MHz.

<sup>[5]</sup> Within 10 % of the final gain.

#### SiGe: C LNA MMIC for GPS, GLONASS, Galileo and Compass

## 9. Package outline

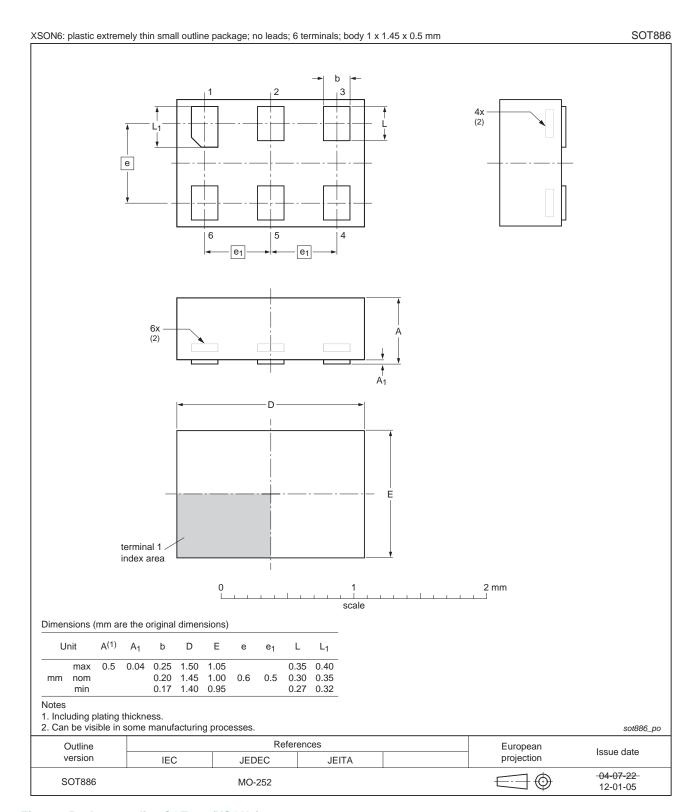


Fig 33. Package outline SOT886 (XSON6)

1U7005 All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2012. All rights reserved.

#### SiGe:C LNA MMIC for GPS, GLONASS, Galileo and Compass

## 10. Abbreviations

Table 12. Abbreviations

-	
Acronym	Description
AC	Alternating Current
ATM	Automated Teller Machine (cash dispenser)
DC	Direct Current
GLONASS	GLObal NAvigation Satellite System
GNSS	Global Navigation Satellite System
GPS	Global Positioning System
НВМ	Human Body Model
MMIC	Monolithic Microwave Integrated Circuit
PC	Personal Computer
PCB	Printed Circuit Board
RF	Radio Frequency
SAW	Surface Acoustic Wave
SiGe:C	Silicon Germanium Carbon
·	

## 11. Revision history

Table 13. Revision history

14510 101 110					
Document ID	Release date	Data sheet status	Change notice	Supersedes	
BGU7005 v.5	20120329	Product data sheet	-	BGU7005 v.4	
Modifications:	<ul> <li>Added 'Compa</li> </ul>	ass' to descriptive title			
	<ul> <li>Section 1.2 on page 1: row 6, changed 2.85 V to 3.1 V</li> </ul>				
	• Table 1 on page	ge 2: changed max.value V <sub>CC</sub> fror	m 2.85 V to 3.1 V		
	<ul> <li>Table 7 on page</li> </ul>	ge 4: changed max.value V <sub>CC</sub> from	m 2.85 V to 3.1 V		
	• Table 8 on page	ge 5: changed max.value V <sub>CC</sub> fror	m 2.85 V to 3.1 V		
	• Table 5 on page	ge 3: several additions and chang	es		
	• Figure 8 on pa	age 8: corrected figure titles			
	• Figure 9 on pa	age 8: corrected figure titles			
BGU7005 v.4	20110506	Product data sheet	-	BGU7005 v.3	
BGU7005 v.3	20100623	Product data sheet	-	BGU7005_2	
BGU7005_2	20100304	Product data sheet	-	BGU7005_1	
BGU7005 1	20091028	Preliminary data sheet	-	-	

#### SiGe:C LNA MMIC for GPS, GLONASS, Galileo and Compass

## 12. Legal information

#### 12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

#### 12.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

**Product specification** — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

#### 12.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

**No offer to sell or license** — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

BGU7005

All information provided in this document is subject to legal disclaimers.

© NXP B.V. 2012. All rights reserved.

#### SiGe: C LNA MMIC for GPS, GLONASS, Galileo and Compass

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any

liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

#### 12.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

#### 13. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

**BGU7005 NXP Semiconductors** 

#### SiGe: C LNA MMIC for GPS, GLONASS, Galileo and Compass

#### 14. Contents

1	Product profile
1.1	General description
1.2	Features and benefits
1.3	Applications 2
1.4	Quick reference data 2
2	Pinning information 2
3	Ordering information 3
4	Marking 3
5	Limiting values 3
6	Thermal characteristics 3
7	Characteristics 4
8	Application information 6
8.1	GNSS LNA
8.2	GPS front-end
8.3	Characteristics GPS front-end 14
9	Package outline
10	Abbreviations
11	Revision history 17
12	Legal information
12.1	Data sheet status
12.2	Definitions
12.3	Disclaimers
12.4	Trademarks19
13	Contact information 19
14	Contents

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

# NXP:

OM7624/BGU7005,598 OM7624/BGU7005FE,598